



# PJT7600

## 20V Complementary Enhancement Mode MOSFET – ESD Protected

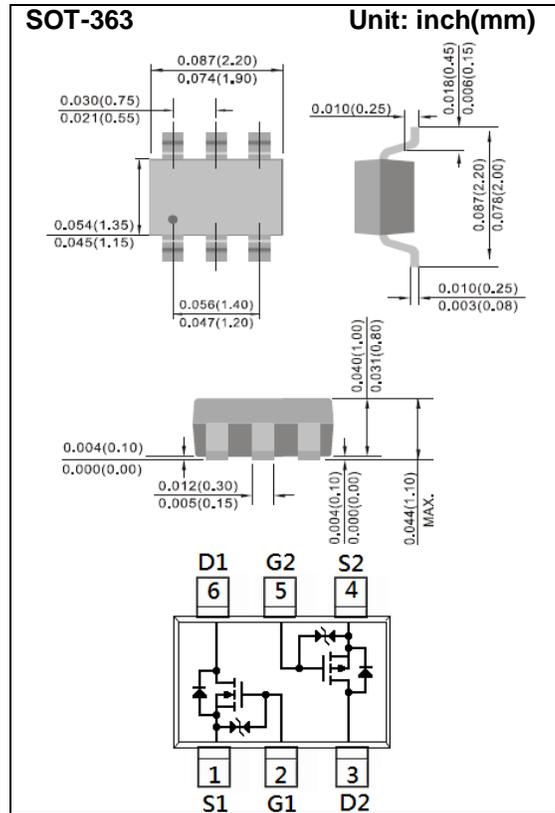
**Voltage** 20 / -20V **Current** 1 / -0.7A

### Features

- Advanced Trench Process Technology
- Specially Designed for Switch Load, PWM Application, etc.
- ESD Protected 2KV HBM
- Lead free in compliance with EU RoHS 2011/65/EU directive
- Green molding compound as per IEC61249 Std. (Halogen Free)

### Mechanical Data

- Case: SOT-363 Package
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.0002 ounces, 0.006 grams
- Marking: T60



### Maximum Ratings and Thermal Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER	SYMBOL	N-Ch LIMIT	P-Ch LIMIT	UNITS	
Drain-Source Voltage	V <sub>DS</sub>	20	-20	V	
Gate-Source Voltage	V <sub>GS</sub>	±8	±8	V	
Continuous Drain Current	I <sub>D</sub>	1	-0.7	A	
Pulsed Drain Current (Note 4)	I <sub>DM</sub>	4	-2.8	A	
Power Dissipation	P <sub>D</sub>	T <sub>a</sub> =25°C		350	mW
		Derate above 25°C		2.8	mW/°C
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55~150		°C	
Typical Thermal resistance - Junction to Ambient (Note 3)	R <sub>θJA</sub>	357		°C/W	



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## N-Channel Electrical Characteristics ( $T_A=25^{\circ}\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
<b>Static</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	20	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	0.5	0.8	1.0	V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=4.5V, I_D=1A$	-	114	150	m $\Omega$
		$V_{GS}=2.5V, I_D=0.7A$	-	160	215	
		$V_{GS}=1.8V, I_D=0.3A$	-	280	400	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=20V, V_{GS}=0V$	-	0.01	1	$\mu A$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 8V, V_{DS}=0V$	-	$\pm 2$	$\pm 10$	$\mu A$
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	$V_{DS}=10V, I_D=1A,$ $V_{GS}=4.5V$ (Note 1,2)	-	1.6	-	nC
Gate-Source Charge	$Q_{gs}$		-	0.3	-	
Gate-Drain Charge	$Q_{gd}$		-	0.41	-	
Input Capacitance	$C_{iss}$	$V_{DS}=10V, V_{GS}=0V,$ $f=1.0\text{MHz}$	-	92	-	pF
Output Capacitance	$C_{oss}$		-	25	-	
Reverse Transfer Capacitance	$C_{rss}$		-	9.1	-	
<b>Switching</b>						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=10V, I_D=1A,$ $V_{GS}=4.5V, R_G=6\Omega$ (Note 1,2)	-	5.8	-	ns
Turn-On Rise Time	$t_r$		-	25.7	-	
Turn-Off Delay Time	$t_{d(off)}$		-	41	-	
Turn-Off Fall Time	$t_f$		-	31	-	
<b>Drain-Source Diode</b>						
Maximum Continuous Drain-Source Diode Forward Current	$I_S$	---	-	-	1	A
Diode Forward Voltage	$V_{SD}$	$I_S=1A, V_{GS}=0V$	-	0.85	1.2	V



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PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
<b>Static</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=-250\mu A$	-20	-	-	V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.5	-0.64	-1	V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS}=-4.5V, I_D=-0.7A$	-	260	325	m $\Omega$
		$V_{GS}=-2.5V, I_D=-0.6A$	-	310	420	
		$V_{GS}=-1.8V, I_D=-0.5A$	-	400	600	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=-20V, V_{GS}=0V$	-	-0.01	-1	$\mu A$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 8V, V_{DS}=0V$	-	$\pm 3.5$	$\pm 10$	$\mu A$
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	$V_{DS}=-10V, I_D=-0.7A,$ $V_{GS}=-4.5V$ (Note 1,2)	-	2.2	-	nC
Gate-Source Charge	$Q_{gs}$		-	0.4	-	
Gate-Drain Charge	$Q_{gd}$		-	0.5	-	
Input Capacitance	$C_{iss}$	$V_{DS}=-10V, V_{GS}=0V,$ $f=1.0\text{MHZ}$	-	151	-	pF
Output Capacitance	$C_{oss}$		-	27	-	
Reverse Transfer Capacitance	$C_{rss}$		-	8.8	-	
<b>Switching</b>						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=-10V, I_D=-0.7A,$ $V_{GS}=-4.5V, R_G=6\Omega$ (Note 1,2)	-	2.2	-	ns
Turn-On Rise Time	$t_r$		-	19.2	-	
Turn-Off Delay Time	$t_{d(off)}$		-	6.2	-	
Turn-Off Fall Time	$t_f$		-	23	-	
<b>Drain-Source Diode</b>						
Maximum Continuous Drain-Source Diode Forward Current	$I_S$	---	-	-	-1	A
Diode Forward Voltage	$V_{SD}$	$I_S=-1A, V_{GS}=0V$	-	-0.86	-1.2	V

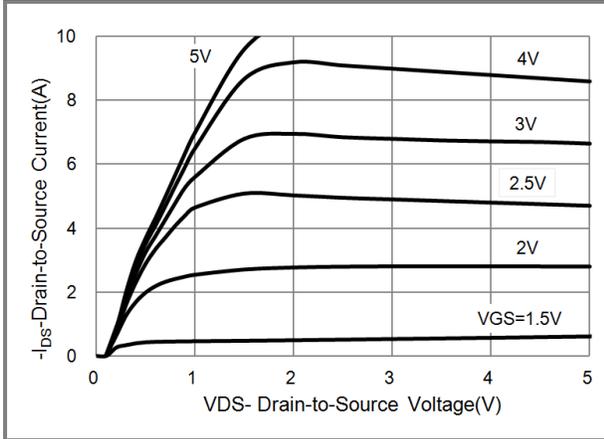
**NOTES :**

1. Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$
2. Essentially independent of operating temperature typical characteristics.
3.  $R_{\theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins mounted on a 1 inch FR-4 with 2oz. square pad of copper.
4. The maximum current rating is package limited.

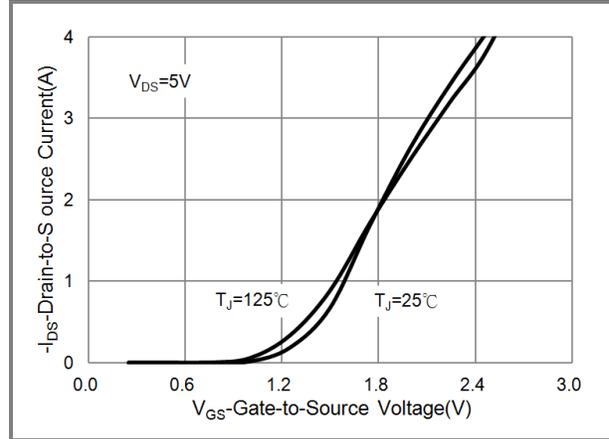


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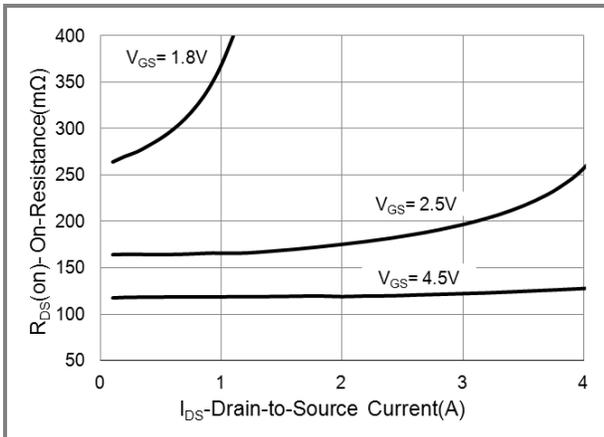
## N-Channel TYPICAL CHARACTERISTIC CURVES



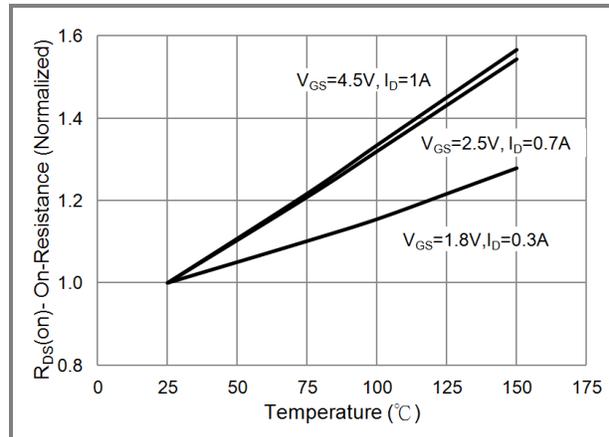
**Fig.1 On-Region Characteristics**



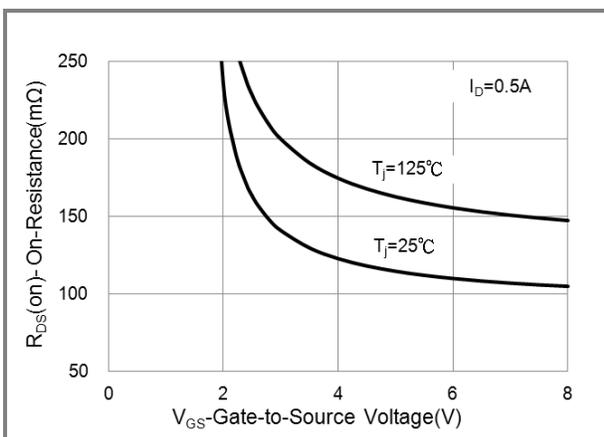
**Fig.2 Transfer Characteristics**



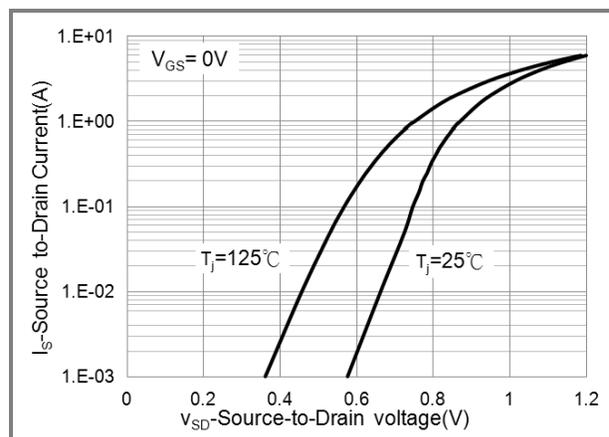
**Fig.3 On-Resistance vs. Drain Current**



**Fig.4 On-Resistance vs. Junction temperature**



**Fig.5 On-Resistance Variation with V\_GS.**



**Fig.6 Body Diode Characteristic**



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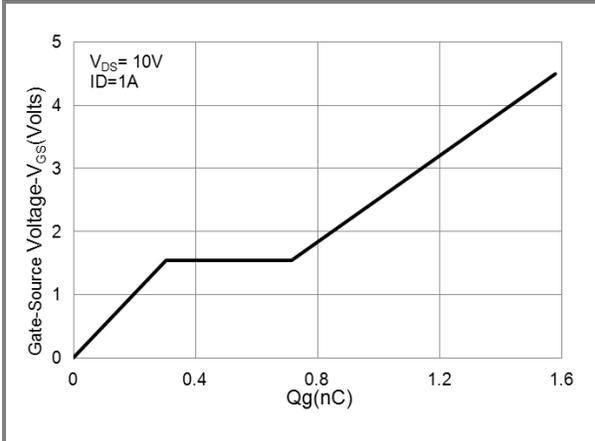


Fig.7 Gate-Charge Characteristics

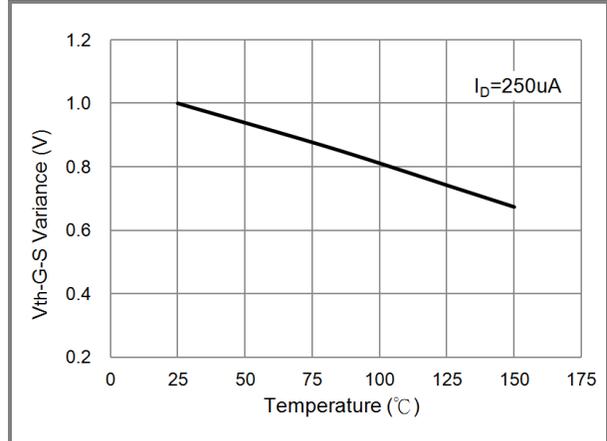


Fig.8 Threshold Voltage Variation with Temperature.

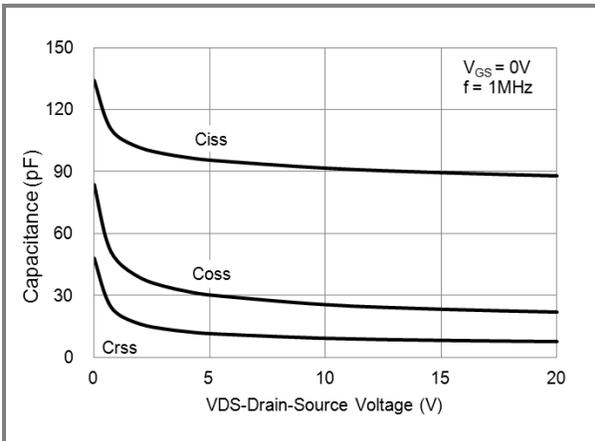
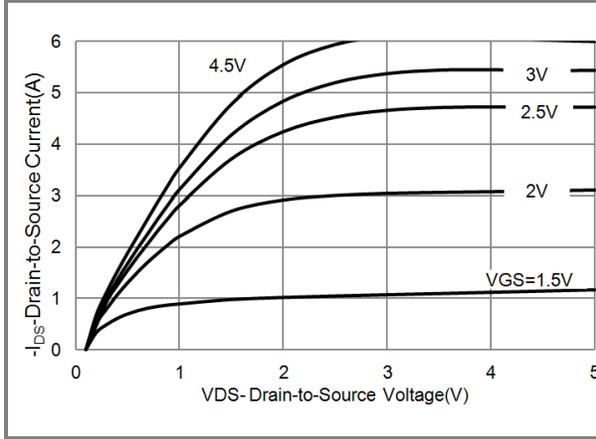


Fig.9 Capacitance vs. Drain-Source Voltage.

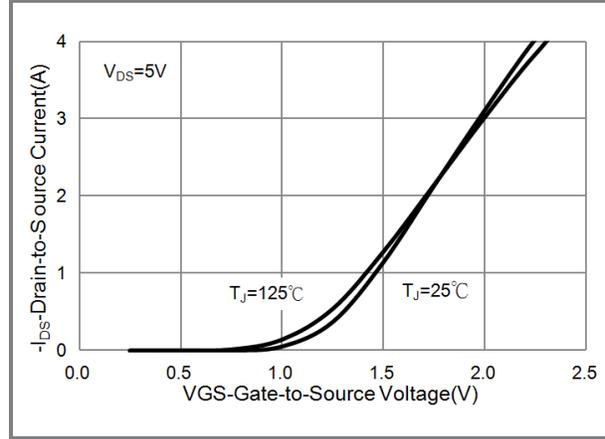


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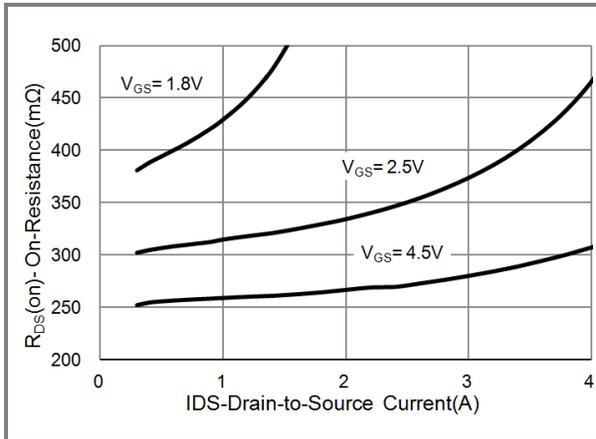
## P-Channel TYPICAL CHARACTERISTIC CURVES



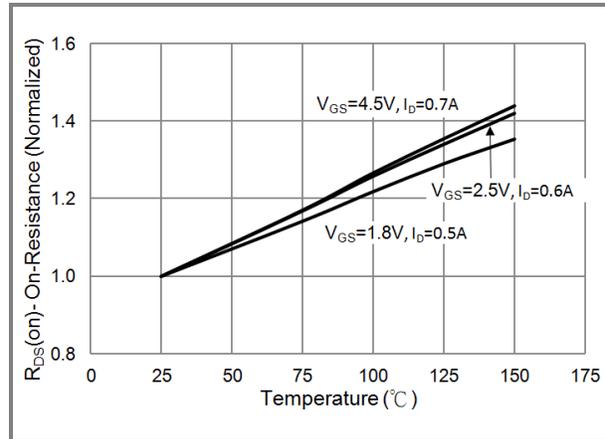
**Fig.1 On-Region Characteristics**



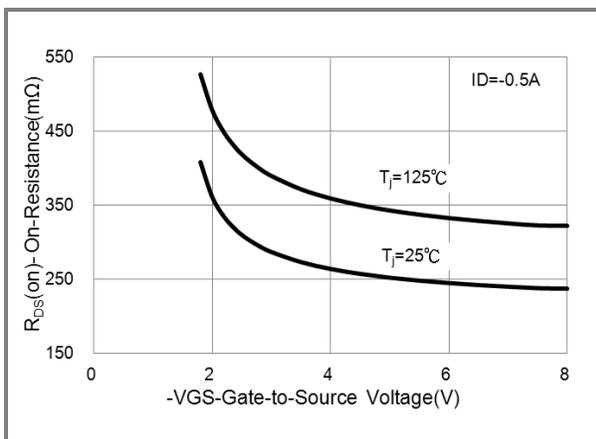
**Fig.2 Transfer Characteristics**



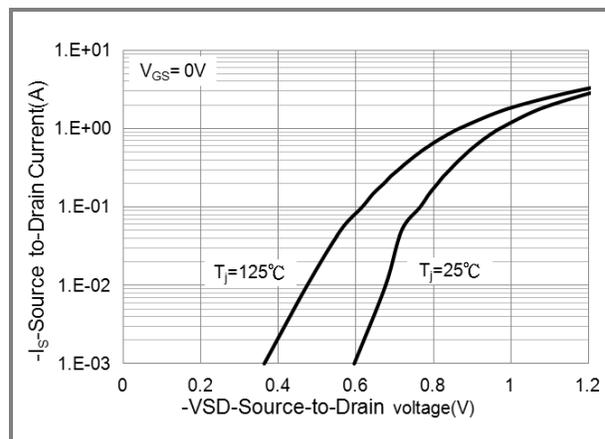
**Fig.3 On-Resistance vs. Drain Current**



**Fig.4 On-Resistance vs. Junction temperature**



**Fig.5 On-Resistance Variation with V\_GS.**



**Fig.6 Body Diode Characteristics**



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## P-Channel TYPICAL CHARACTERISTIC CURVES

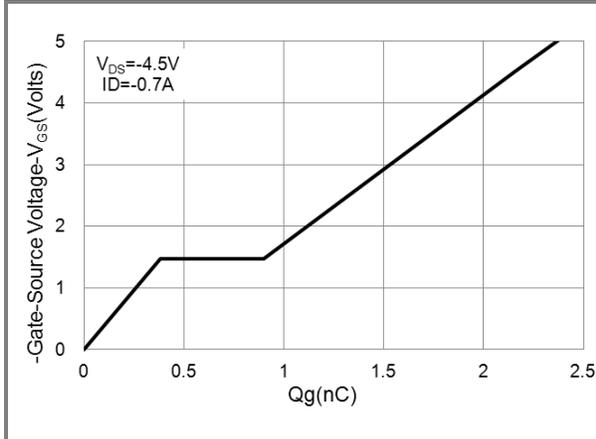


Fig.7 Gate-Charge Characteristics

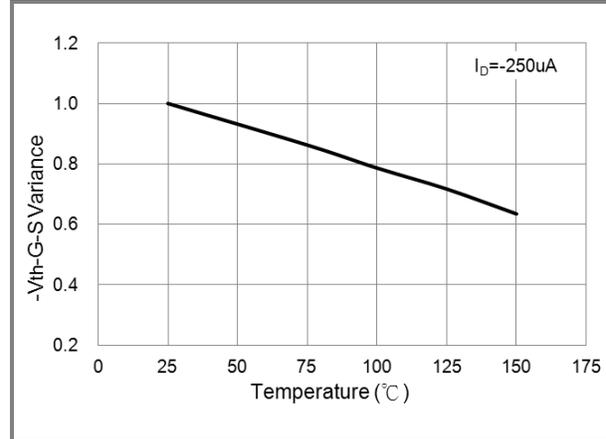


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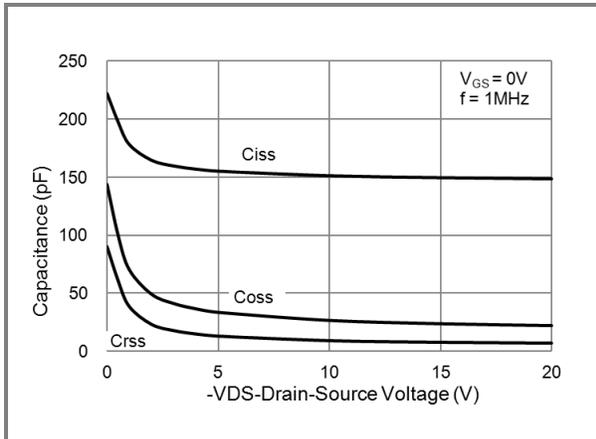


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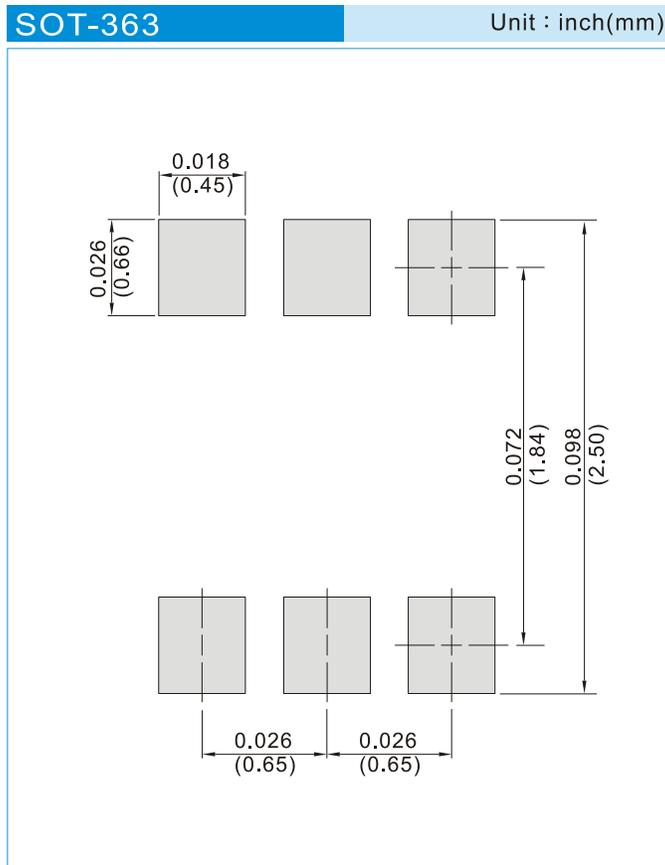


# PJT7600

## PART NO PACKING CODE VERSION

Part No Packing Code	Package Type	Packing type	Marking	Version
PJT7600_R1_00001	SOT-363	3K pcs / 7" reel	T60	Halogen free
PJT7600_R2_00001	SOT-363	10K pcs / 13" reel	T60	Halogen free

## MOUNTING PAD LAYOUT





## PJT7600

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